

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Keun Kook KIM	11/11/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Hynix Semiconductor Inc.
<b>Street Address:</b>	San 136-1, Ami-ri, Bubal-eup
<b>City:</b>	Icheon-si Gyeonggi-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12975043
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(630)908-7653
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	630 908 7652
<b>Email:</b>	uspto.actions@wwplaw.com
<b>Correspondent Name:</b>	William Park & Associates LTD.
<b>Address Line 1:</b>	930 N. York Road, Suite 201
<b>Address Line 4:</b>	Hinsdale, ILLINOIS 60521
<b>ATTORNEY DOCKET NUMBER:</b>	PA0041-0
<b>NAME OF SUBMITTER:</b>	Woochoon W. Park
<b>Total Attachments: 3</b> source=PA0041-0_Assignment#page1.tif source=PA0041-0_Assignment#page2.tif source=PA0041-0_Assignment#page3.tif	

OP \$40.00 12975043

DOCKET:

PATENT

**ASSIGNMENT OF APPLICATION**

Now, therefore, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the assignor(s)

**ASSIGNOR(S)****KIM, Keun Kook**

#132-502, Jugong Apt., Dunchon 1-dong, Gangdong-gu, Seoul, Republic of Korea

by these presents do sell, assign and transfer unto said assignee

**ASSINGEE****Hynix Semiconductor Inc.**

San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do, Republic of Korea

and the heirs, successors, assigns and legal representatives of the assignee the full and exclusive right to the said invention in the United States which are disclosed in the U.S. patent application titled

**FUSE CIRCUIT WITH ENSURED FUSE CUT STATUS**

for which an application for a United States Patent was filed on \_\_\_\_\_  
Application Number \_\_\_\_\_; or

for which an application for a United States Patent was executed by the undersigned on \_\_\_\_\_

and any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

The assignor(s) agree promptly upon request of the Assignee, its heirs, successors, assigns and legal representatives of the assignee to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney,

DOCKET:

PATENT

37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application. In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

**CLAIM OF FOREIGN PRIORITY BENEFITS**

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority NOT Claimed?	Certified Copy Attached?	
				YES	NO
10-2010-0029515	KR	03/31/2010	<input type="checkbox"/>	<input type="checkbox"/>	<input checked="" type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>

**POWER OF ATTORNEY TO PROSECUTE APPLICATIONS BEFORE THE USPTO**

I hereby appoint practitioner(s) associated with the **Customer Number 96767** as attorney(s) or agent(s) to represent the undersigned before the United States Patent and Trademark Office (USPTO) in connection with any and all patent applications assigned only to the undersigned according to the USPTO assignment records or assignment documents attached to this form in accordance with 37 CFR 3.73(b).

Send correspondence to:

Woochoon William Park  
 William Park & Associates Ltd.  
 930 N. York Road, Suite 201  
 Hinsdale IL 60521

Phone: 630-908-7652  
 Fax: 630-908-7653  
 Email: uspto.actions@wwplaw.com

DOCKET:

PATENT

**SINGATURE(S)**

NAME OF SOLE OR FIRST INVENTOR			
<i>Given Name (first and middle [if any])</i> Keun Kook		<i>Family Name or Surname</i> KIM	
<i>Inventor's Signature</i> <i>Keun Kook</i>		<i>Date</i> November 11, 2010	
<i>Residence: City</i> Seoul	<i>Residence: State</i> Seoul, Republic of Korea	<i>Residence: Country</i> Republic of Korea	<i>Citizenship</i> Republic of Korea
<i>Full Mailing Address</i> #132-502, Jugong Apt., Dunchon 1-dong, Gangdong-gu, Seoul, Republic of Korea ***			

NAME OF SECOND JOINT INVENTOR			
<i>Given Name (first and middle [if any])</i>		<i>Family Name or Surname</i>	
<i>Inventor's Signature</i>		<i>Date</i>	
<i>Residence: City</i>	<i>Residence: State</i>	<i>Residence: Country</i>	<i>Citizenship</i>
<i>Full Mailing Address</i> <i>Residence: City</i> ***			

NAME OF THIRD JOINT INVENTOR			
<i>Given Name (first and middle [if any])</i>		<i>Family Name or Surname</i>	
<i>Inventor's Signature</i>		<i>Date</i>	
<i>Residence: City</i>	<i>Residence: State</i>	<i>Residence: Country</i>	<i>Citizenship</i>
<i>Full Mailing Address</i>			